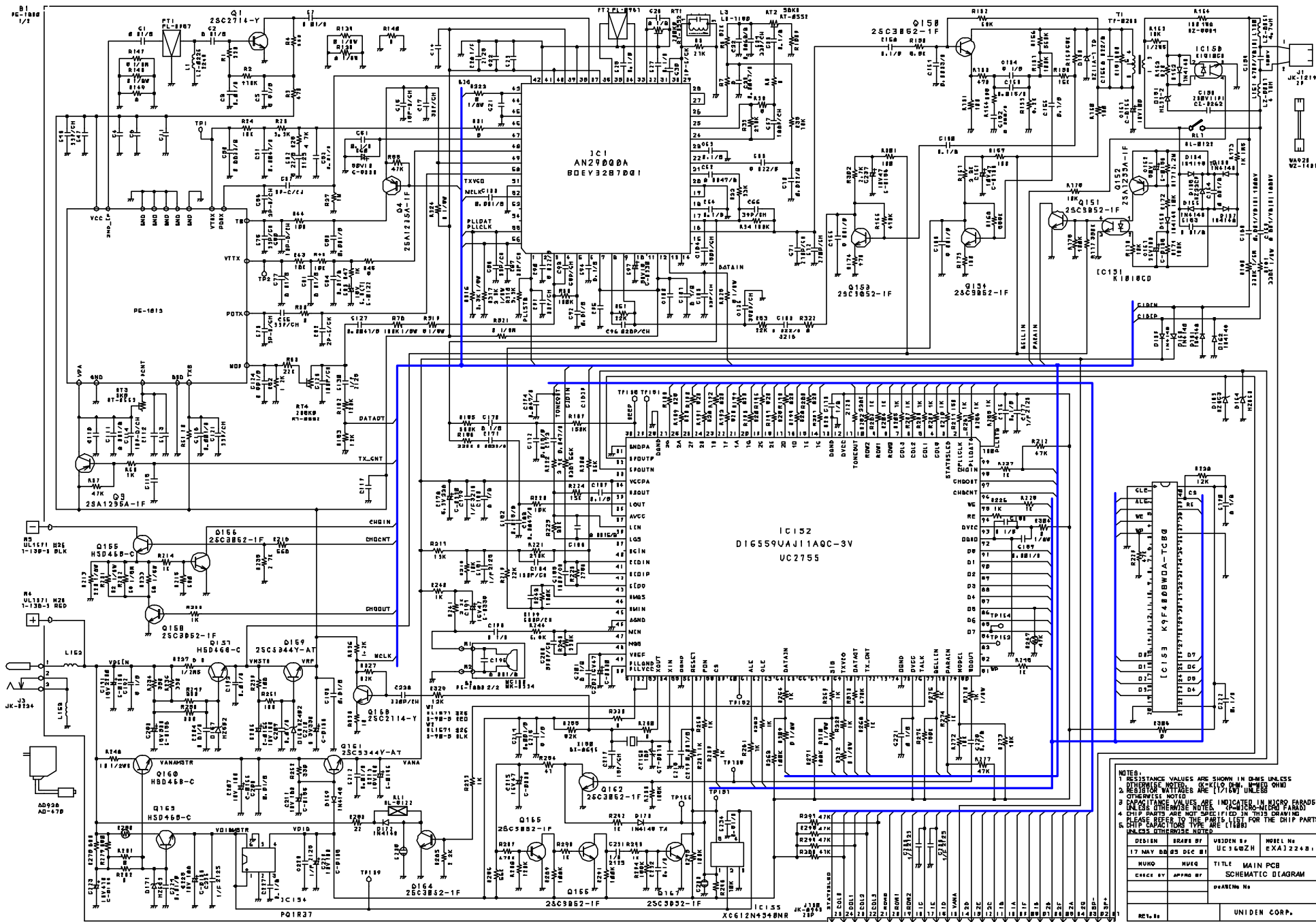
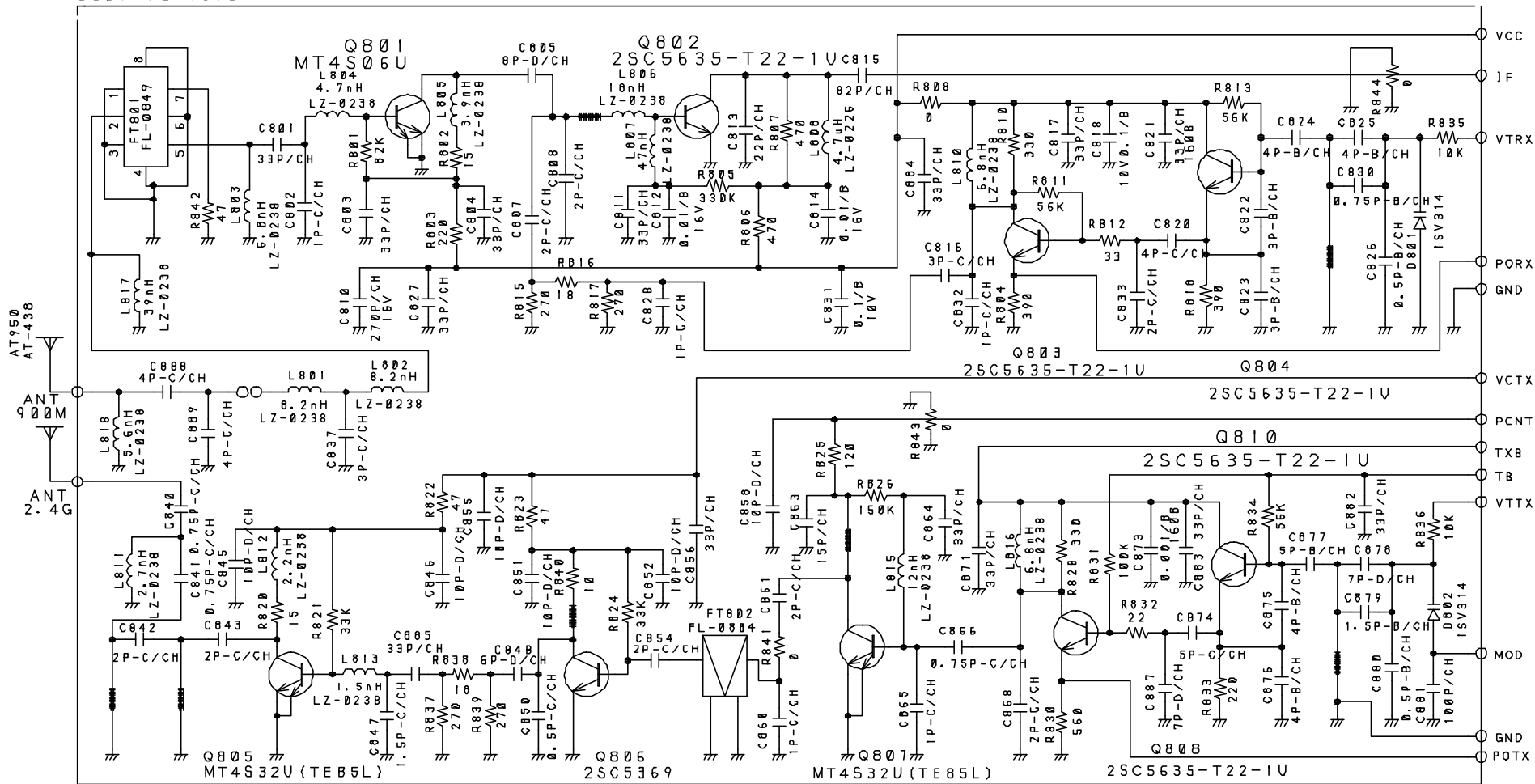




NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE SPECIFIED. RESISTANCE VALUES ARE IN PARETHESIS.
2. RESISTOR TOLERANCES ARE (1%) UNLESS OTHERWISE SPECIFIED.
3. RESISTANCE VALUES ARE INDICATED IN MICRO OHMS UNLESS OTHERWISE SPECIFIED.
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING UNLESS SPECIFICALLY NOTED FOR THE CHIP PART.
5. CAPACITANCE VALUES ARE IN PARETHESIS UNLESS OTHERWISE SPECIFIED.
6. CAPACITANCE VALUES ARE IN PARETHESIS UNLESS OTHERWISE SPECIFIED.

DESIGN	BOARD	VERSION	MODEL
17 MAY 68	05 DEC 81	3.0ZWH	EXA1224-8
MFGD	MFGD	TITLE	
CHECK BY	APPROVED BY	SCHEMATIC DIAGRAM	
DRAWING No.			

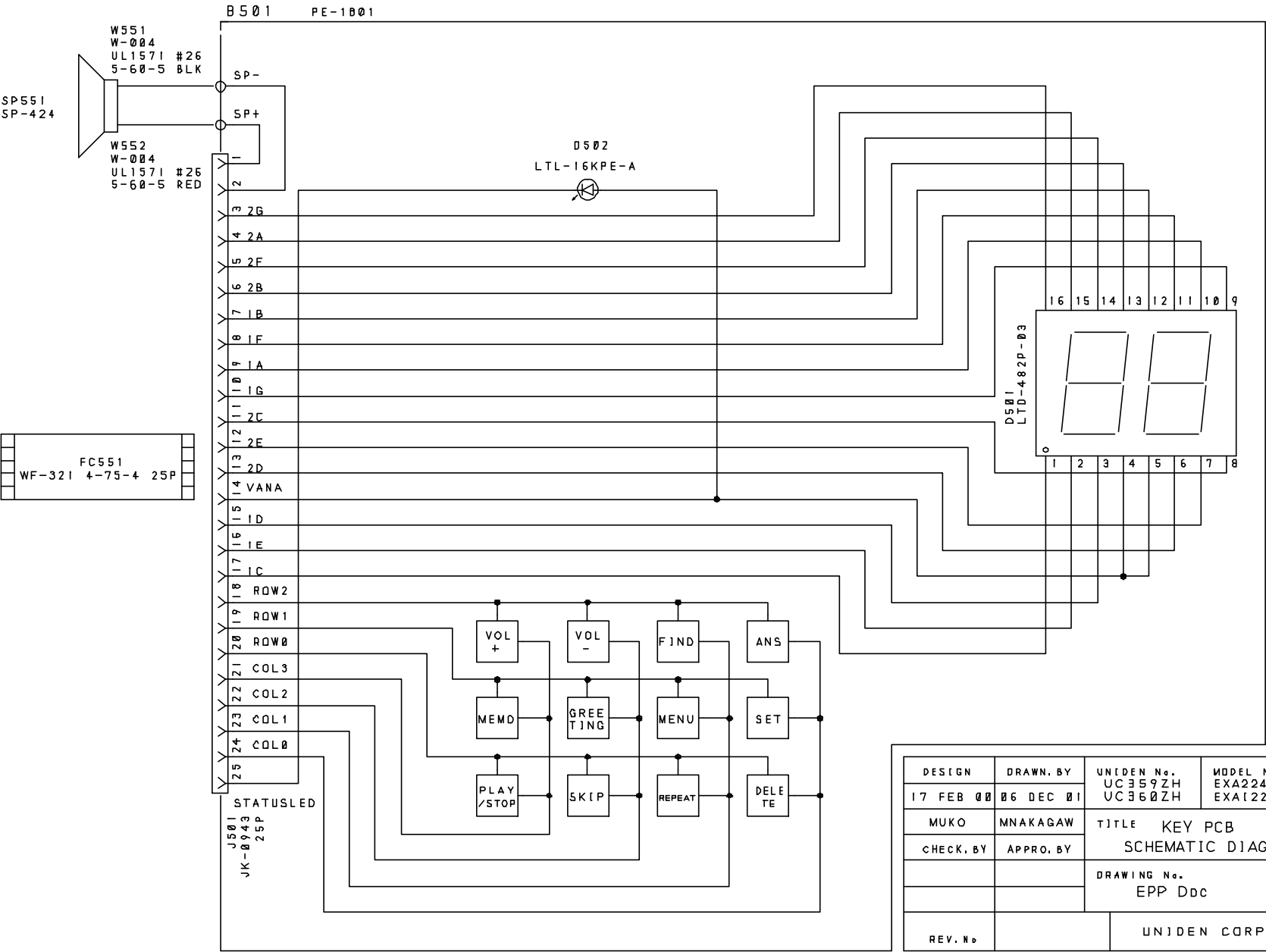
UNIDEN CORP.



NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W (1005)] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. CHIP CAPACITORS TYPE ARE [1005] UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
May/14/01	01/12/05	UC360ZH	EXA12248i
YUI	SUWA	TITLE BASE RF SCHEMATIC DIAGRAM	
CHECK BY	APPRO. BY		
		DRAWING No	
REV No		UNIDEN CORP.	



DESIGN	DRAWN BY	UNIDEN No. UC359ZH	MODEL No. EXA2245
17 FEB 00	06 DEC 01	UC360ZH	EXA122401
MUKO	MNAKAGAW	TITLE KEY PCB	
CHECK BY	APPRO BY	SCHEMATIC DIAGRAM	
		DRAWING No.	
		EPP Ddc	
REV. No.		UNIDEN CORP	